

- ♦ STRUCTURE
- ♦ PRODUCT I<sup>2</sup>C BUS Serial EEPROMs
- ♦ SERIES ADVANTAGE SERIES
- ♦ FAMILY BR24C□□ family
- ♦ TYPE
- Supply voltage  $1.8V \sim 5.5V$ /Opreating temperature  $-40^{\circ}C \sim +85^{\circ}C$ type MBER BR24C  $\Box \Box -10 \Box U 1.8$
- ♦ PART NUMBER

PART NUMBER	PACKAGE	DENSITY
BR24C01A -10SU-1.8		1Kbit
BR24C02N -10SU-1.8		2Kbit
BR24C04N -10SU-1.8	8-lead	4Kbit
BR24C08AN -10SU-1.8	JEDECSOIC	8Kbit
BR24C16AN -10SU-1.8	]	16Kbit
BR24C32AN -10SU-1.8		32Kbit
BR24C01A -10TU-1.8		1Kbit
BR24C02 -10TU-1.8		2Kbit
BR24C04 -10TU-1.8	8-lead	4Kbit
BR24C08A -10TU-1.8	TSSOP	8Kbit
BR24C16A -10TU-1.8	]	16Kbit
BR24C32A -10TU-1.8	7	32Kbit

Silicon Monolithic Integrated Circuit

♦ FEATURE

Two wire serial interface Endurance : 1,000,000 erase/write cycles Data retention : 100years Intial Data FFh in all address

#### ♦ ABSOLUTE MAXIMUM RATING

Parameter	Symbol	Rating	Unit
Operating Temperature	Topr	-40~85	°C
Storage Temperature	Tstg	-65~125	°C
Voltage on Any Pin with Respect to Ground	-	-0.3~Vcc+0.3	V
Maximum Operating Voltage	Vcc	-0.3~6.5	V

### ♦ POWER DISSIPATION (Ta=25°C)

PACKAGE	Rating	Unit
8-lead JEDECSOIC	450 *1	mW
8-lead TSSOP	330 *2	mW

\* Degradation is done at 4.5mW/°C(\*1), 3.3mW/°C(\*2)for operation above 25°C

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## $\diamondsuit$ DC OPERATING CHARACTERISTICS

Parameter	Symbol	Min	Мах	Unit	Test Conditions
Supply Current Vcc=5.0V	LCCI	-	1.0	mA	READ at 100 kHz
Supply Current Vcc=5.0V	I <sub>CC2</sub>	-	3.0	mA	WRITE at 100 kHz
Standby Current Vcc=1.8V	I <sub>SB1</sub>	-	3.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Standby Current Vcc=2.5V	l <sub>SB2</sub>	-	4.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Standby Current Vcc=2.7V	l <sub>SB3</sub>	~	4.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Standby Current Vcc=5.0V	I <sub>SB4</sub>	-	18.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Input Leakage Current	lu	-	3.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Output Leakage Current	4 <sub>to</sub>	-	3.0	μA	V <sub>OUT</sub> =V <sub>CC</sub> or GND
	v	-	Vccx0.3	v	2.5V≦Vcc≦5.5V
Input Low Level	VL	-	Vccx0.2	1	1.8V≦Vcc<2.5V
	v	Vccx0.7	-	v	2.5V≦Vcc≦5.5V
Input High Level	<sub>₩</sub>	Vccx0.8	-	1	1.8V≦Vcc<2.5V
Output Low Level Vcc=3.0V	VoLI	-	0.4	v	l <sub>oL</sub> =2.1mA
Output Low Level Vcc=1.8V	V <sub>OL2</sub>	-	0.2	v	l <sub>oL</sub> =0.15mA

## $\diamondsuit$ AC OPERATING CHARACTERISTICS

BR24C01A/02/04/08A/16A.Unless otherwise specified,Vcc=1.8V to 5.5V, Ta=-40°C to 85°C

<b>D</b> 1		1.	.8V	2.5V,2	7V,5.0V	Unit
Parameter	Symbol	Min	Max	Min	Max	
Clock Frequency, SCL	f <sub>SCL</sub>	-	100	-	400	kHz
Clock Pulse Width Low	t <sub>LOW</sub>	4.7	-	1.2	-	μs
Clock Pulse Width High	t <sub>HIGH</sub>	4.0	-	0.6	-	μs
Noise Suppression Time	ţ,	-	100	-	50	ns
Clock Low to Data Out Valid	t <sub>M</sub>	0.1	4.5	0.1	0.9	μs
Time the bus must be free before a new transmission can start	t <sub>BUF</sub>	4.7	-	1.2	-	μs
Start Hold Time	thd.sta	4.0	-	0.6	-	μs
Start Setup Time	t <sub>su.sta</sub>	4.7	-	0.6	-	μs
Data In Hold Time	t <sub>hd.dat</sub>	0	-	0	-	μs
Data In Setup Time	t <sub>su.dat</sub>	200	-	100	-	ns
Inputs Rise Time *1	t <sub>R</sub>	-	1.0	-	0.3	μs
Inputs Fall Time *1	t <sub>f</sub>	-	300	-	300	ns
Stop Setup Time	t <sub>su.sto</sub>	4.7	-	0.6	-	μs
Data Out Hold Time	t <sub>он</sub>	100	-	50	-	ns
Write Cycle Time	t <sub>wr</sub>	-	5	-	5	ms
Endurance *1 5.0V, 25°C	Endurance	1M	-	ім	-	Write Cycles

BR24C32A Unless otherwise specified,Vcc=1.8V to 5.5V, Ta=-40°C to 85°C

Parameter	Symbol	Min	Max	Unit	Test Conditions
Supply Current Vcc=5.0V	I <sub>CC1</sub>	-	1.0	mA	READ at 400 kHz
Supply Current Vcc=5.0V	I <sub>CC2</sub>	-	3.0	mA	WRITE at 400 kHz
Standby Current Vcc=1.8V	l <sub>se</sub> ,	-	1.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Standby Current Vcc=2.5V	I <sub>SB2</sub>	-	2.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Standby Current Vcc=2.7V	I <sub>SB3</sub>	-	2.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Standby Current Vcc=5.0V	I <sub>SB4</sub>	-	6.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Input Leakage Current	ես	-	3.0	μA	V <sub>IN</sub> =V <sub>CC</sub> or GND
Output Leakage Current	l <sub>LO</sub>	-	3.0	μA	V <sub>OUT</sub> =V <sub>CC</sub> or GND
	.,	-	Vccx0.3		2.5V≦Vcc≦5.5V
input Low Level	VL	-	Vccx0.2	v	1.8V≦Vcc<2.5V
	.,	Vccx0.7	-		2.5V≦Vcc≦5.5V
Input High Level	VH	Vccx0.8	-	v	1.8V≦Vcc<2.5V
Output Low Level Vcc=3.0V	VoLi	-	0.4	v	l <sub>oL</sub> =2.1mA
Output Low Level Vcc=1.8V	VoLz	-	0.2	v	I <sub>OL</sub> =0.15mA

OThis product is not designed for protection against radioactive rays.

### ♦ BLOCK DIAGRAM

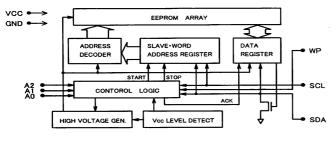


Fig.-1 BLOCK DIAGRAM

### BR24C32A.Unless otherwise specified,Vcc=1.8V to 5.5V, Ta=-40°C to 85°C

1.8V 2.5V,2.7V,5.0V Parameter Symbol Unit Min Min Max Max Clock Frequency, SCL \_ 100 \_ 400 kHz f<sub>SCL</sub> Clock Pulse Width Low **t**LOW 4.7 -1.3 \_ μs Clock Pulse Width High 4.0 -0.6 -μs t<sub>HIGH</sub> Noise Suppression Time t, -100 -50 ns Clock Low to Data Out Valid 0.1 4.5 0.1 0.9 μs t<sub>AA</sub> Time the bus must be free befor a new transmission can start 4.7 -1.3 \_ μs t<sub>BUF</sub> Start Hold Time 4.0 0.6 --thd.sta μs Start Setup Time t<sub>su.sta</sub> 4.7 \_ 0.6 \_ μs Data In Hold Time t<sub>hd.dat</sub> 0 -0 μs Data In Setup Time 200 100 ns t<sub>su.dat</sub> -Inputs Rise Time \*1 -1.0 -0.3 μs t<sub>R</sub> 300 300 Inputs Fall Time \*1 te -\_ ns Stop Setup Time 4.7 0.6 μs t<sub>su.sto</sub> Data Out Hold Time t<sub>DH</sub> 100 -50 ns 5 Write Cycle Time t<sub>wR</sub> 5 ms ---Endurance \*1 5.0V, 25°C Write Cycles Endurance ۱M \_ 1M \_

#### PIN No., PIN NAME

PIN No.	PIN NAME
1	A0
2	A1
3	A2
4	GND
5	SDA
6	SCL
7	WP
8	Vcc

\*1 Not 100% TESTED

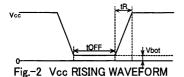
## rohm

### ♦NOTES FOR POWER SUPPLY

Vcc rises through the low voltage region in which internal circuit of IC and the controller are unstable, so that device may not work properly due to an incomplete reset of internal circuit. To prevent this, the device has the feature of P.O.R. and LVCC. In the case of power up, keep the following conditions to ensure functions of P.O.R. and LVCC.

Below 100ms

- 1. It is necessary to be "SDA='H'" and "SCL='L' or 'H'".
- 2. Follow the recommended conditions of tR, tOFF, Vbot for the function of P.O.R. during power up.



 ♦RECOMMENDED CONDITIONS OF tR, tOFF, Vbot

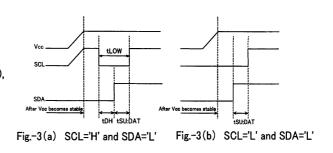
 tR
 tOFF
 Vbot

 Below 10ms
 Above 10ms
 Below 0.3V

Below 0.2V

Above 10ms

- Prevent SDA and SCL from being "High-Z". In case that condition 1. and/or 2. cannot be met, take following actions.
  - A) Unable to keep condition 1.
    - (SDA is "LOW" during power up.)
       → Control SDA ,SCL to be "HIGH" as Fig.-3(a), 3(b).
  - B) Unable to keep condition 2.  $\rightarrow$  After power becomes stable, execute
    - software reset.
  - C) Unable to keep both conditions 1 and 2.
    - $\rightarrow$  Follow the instruction A first, then the instruction B.



## ♦ CAUTIONS ON USE

(1) Absolute maximum ratings

If the absolute maximum ratings such as impressed voltage and action temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

(2) GND electric potential

Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltage is lower than that of GND terminal.

(3) Thermal design

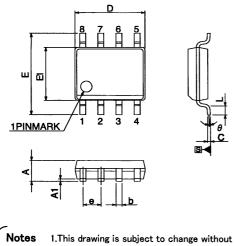
In consideration of permissible loss in actual use condition, carry out heat design with sufficient margin. (4) Terminal to terminal shortcircuit and wrong packaging

When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.

(5) Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.



## ♦ PHYSICAL DIMENSION



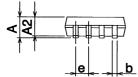
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C	mm				inches	nes	
Symbol	Тур.	Min.	Max.	Тур.	Min.	Max.	
Α	-	1.35	1.75	-	0.053	0.069	
A1	-	0.10	0.25	-	0.004	0.010	
b	-	0.31	0.51	-	0.012	0.020	
С	-	0.17	0.25	-	0.007	0.010	
D	-	4.80	5.00	-	0.189	0.197	
е	1.27		-	0.050		_	
D	BSC			BSC		-	
E	-	5.79	6.20	-	0.228	0.244	
E1	-	3.81	3.99	-	0.150	0.157	
L	-	0.40	1.27	-	0.016	0.050	
θ	-	0°	8°	-	0°	8°	

### ♦ 8-lead JEDECSOIC Package Size Data

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<u>+</u> 1 1 2 3 4 <u>1PINMARK</u>	u



Notes 1.This drawing is subject to change without notice. 2.Body dimensions do not include mold flash or protrusion, or gate burns. 3.Reference MO-153

Fig-5 8-lead TSSOP Package Outline

### ♦ 8-lead TSSOP Package Size Data

		mm		inches			
Symbol	Тур.	Min.	Max.	Тур.	Min.	Max.	
A	-	1	1.20	-	-	0.047	
A2	1.00	0.80	1.05	0.039	0.031	0.041	
b	-	0.19	0.30	-	0.007	0.012	
D	3.00	2.90	3.10	0.118	0.114	0.122	
е	0.65			_	0.025		
e	BSC		_	0.025	_	-	
E	6.40		_	0.252			
E	BSC	_	_	0.252	-	-	
E1	4.40	4.30	4.50	0.173	0.169	0.177	
L	0.60	0.45	0.75	0.023	0.017	0.030	
L1	1.00	1.00	0.039	0.000			
	REF	-	_	0.039	-	_	

	Notes
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